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**PATENT APPLICATION
ATTORNEY DOCKET NO. 1375.1000**

**IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor(s): Joan Phillips Waldron, et al. **Confirmation No.:** 2224
Application No.: 09/821,097 **Examiner:** Chiang, Jack
Filing Date: 03/29/2001 **Group Art Unit:** 2642
Title: Method And Apparatus For A Hearing Aid Coupling System

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AMENDMENT B

Sir:

In response to the Examiner's Final Action, dated 08/23/2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

3. (canceled)

9. – 10. (canceled)

11. (currently amended) The coupler device as claimed in claim ~~[[10]]~~ 28 wherein the capacitor and coupler coil form a filter that excludes low and high audio frequencies.

12. (canceled)

14. (original) A coupler device for coupling an audio signal within a handset to a hearing aid having a T-coil for receiving inductively transmitted audio, comprising:

a coil wound around a magnetic core and a capacitor coupled together in series, said capacitor and coil being coupled to a speaker in the handset and physically mounted within said handset.

15. (original) The coupler device as claimed in claim 14, wherein said series connected capacitor and coil are connected in series with said speaker.

17. (canceled)

18. (currently amended) The coupler device as claimed in claim ~~[[17]]~~ 27 wherein said core is formed of a ferrite material.